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PIC18C601/801

High-Performance ROM-less Microcontrollers with External Memory Bus

High Performance RISC CPU:

- C compiler optimized architecture instruction set
- Linear program memory addressing up to 2 Mbytes
- Linear data memory addressing to 4 Kbytes

Device	External Program Memory		On-Chip RAM (bytes)
	On-Chip		
	Maximum Addressing (bytes)	Maximum Single Word Instructions	
PIC18C601	256K	128K	1.5K
PIC18C801	2M	1M	1.5K

- Up to 160 ns instruction cycle:
 - DC - 25 MHz clock input
 - 4 MHz - 6 MHz clock input with PLL active
- 16-bit wide instructions, 8-bit wide data path
- Priority levels for interrupts
- 8 x 8 Single Cycle Hardware Multiplier

Peripheral Features:

- High current sink/source 25 mA/25 mA
- Up to 47 I/O pins with individual direction control
- Three external interrupt pins
- Timer0 module: 8-bit/16-bit timer/counter with 8-bit programmable prescaler
- Timer1 module: 16-bit timer/counter (time-base for CCP)
- Timer2 module: 8-bit timer/counter with 8-bit period register
- Timer3 module: 16-bit timer/counter
- Secondary oscillator clock option - Timer1/Timer3
- Two Capture/Compare/PWM (CCP) modules
CCP pins can be configured as:
 - Capture input: 16-bit, max. resolution 10 ns
 - Compare is 16-bit, max. resolution 160 ns (Tcy)
 - PWM output: PWM resolution is 1- to 10-bit
Max. PWM freq. @:
 - 8-bit resolution = 99 kHz
 - 10-bit resolution = 24.4 kHz
- Master Synchronous Serial Port (MSSP) with two modes of operation:
 - 3-wire SPI™ (Supports all 4 SPI modes)
 - I²C™ Master and Slave mode
- Addressable USART module: Supports Interrupt on Address bit

Advanced Analog Features:

- 10-bit Analog-to-Digital Converter module (A/D) with:
 - Fast sampling rate
 - Conversion available during SLEEP
 - DNL = ±1 LSb, INL = ±1 LSb
 - Up to 12 channels available
- Programmable Low Voltage Detection (LVD) module
 - Supports interrupt on Low Voltage Detection

Special Microcontroller Features:

- Power-on Reset (POR), Power-up Timer (PWRT), and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator
- On-chip Boot RAM for boot loader application
- 8-bit or 16-bit external memory interface modes
- Up to two software programmable chip select signals ($\overline{CS1}$ and $\overline{CS2}$)
- One programmable chip I/O select signal (\overline{CSIO}) for memory mapped I/O expansion
- Power saving SLEEP mode
- Different oscillator options, including:
 - 4X Phase Lock Loop (of primary oscillator)
 - Secondary Oscillator (32 kHz) clock input

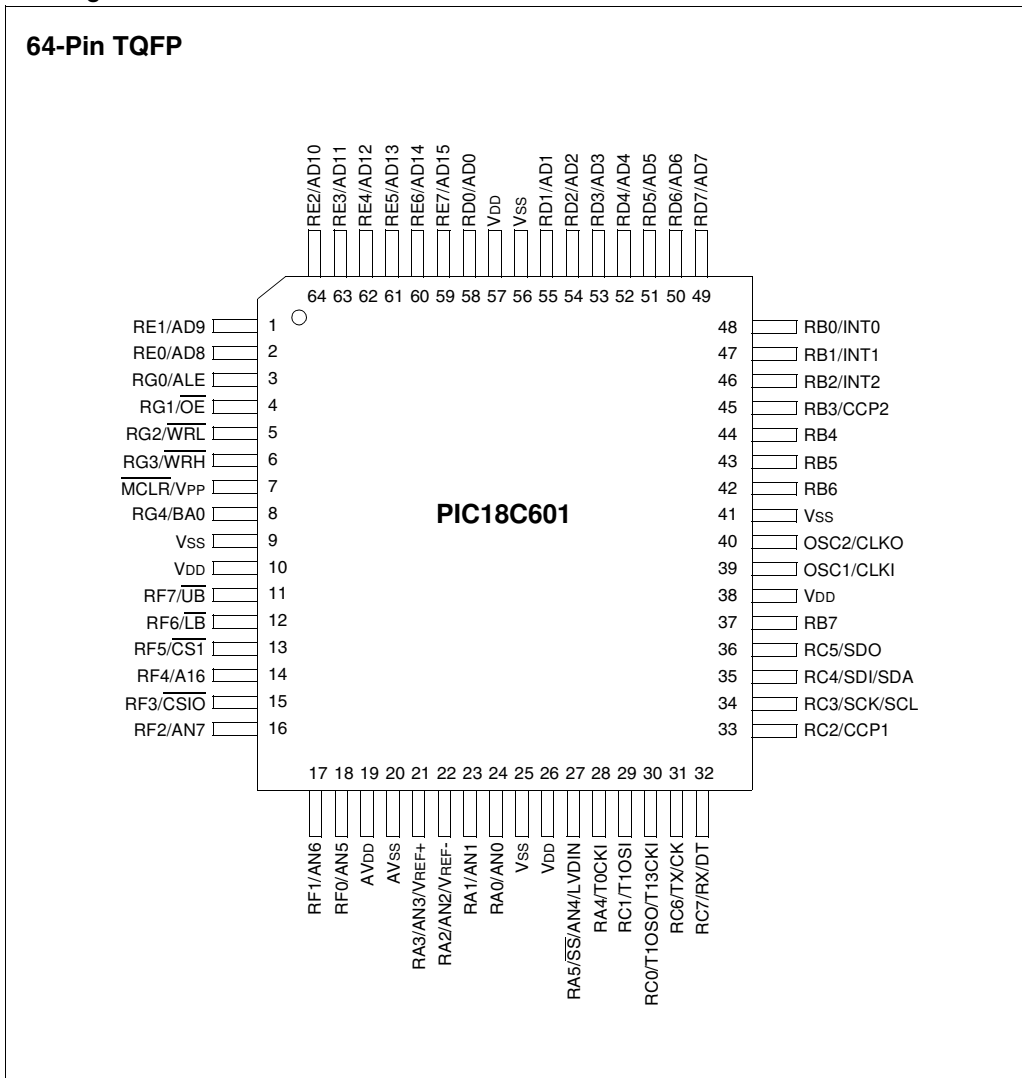
CMOS Technology:

- Low power, high speed CMOS technology
- Fully static design
- Wide operating voltage range (2.0V to 5.5V)
- Industrial and Extended temperature ranges
- Low power consumption

PIC18C601/801

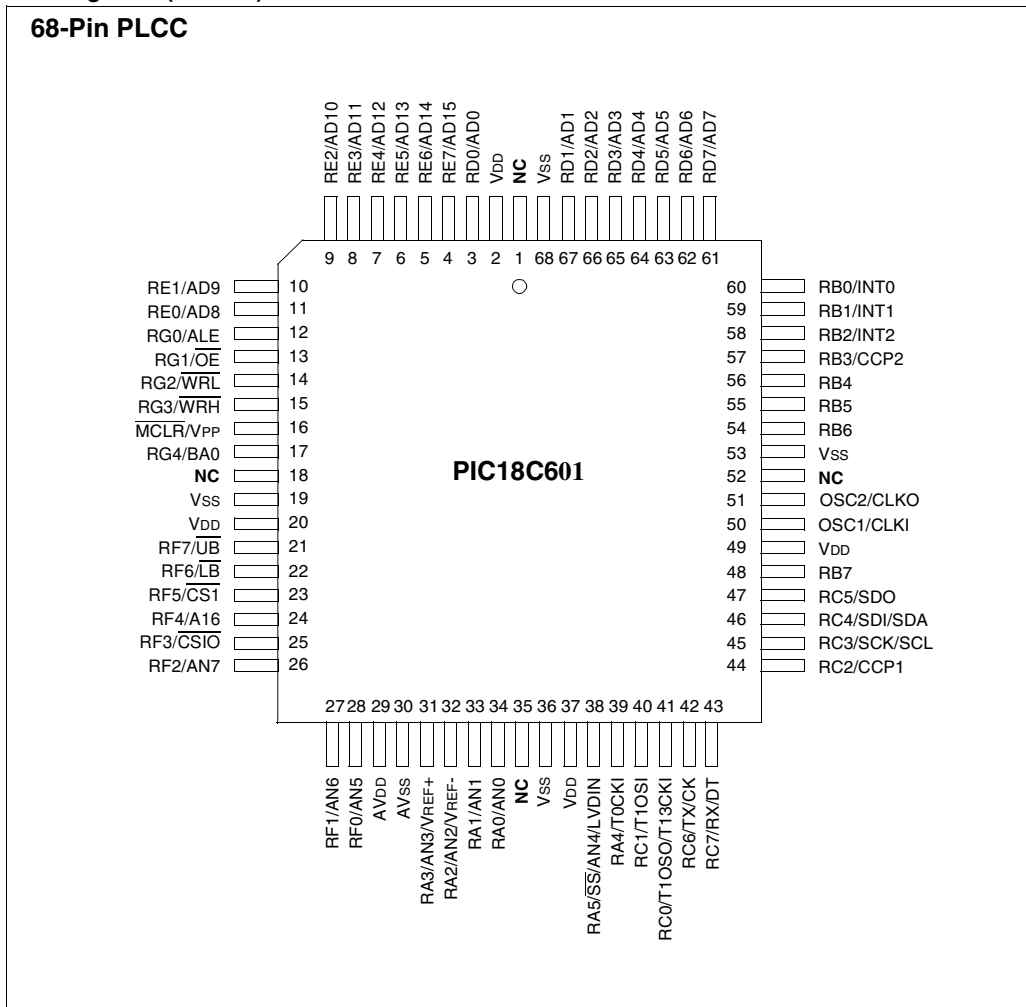
Pin Diagrams

64-Pin TQFP



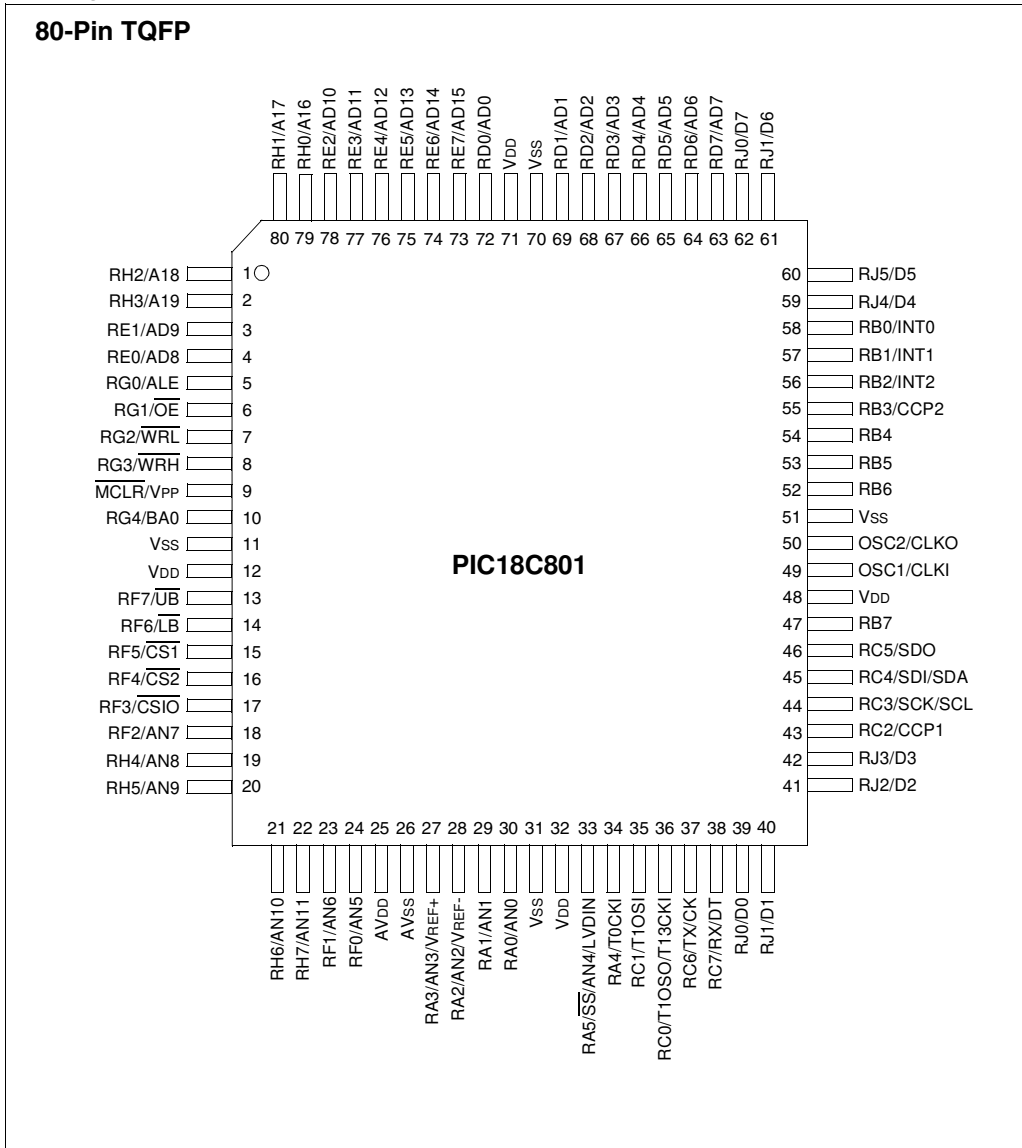
Pin Diagrams (Cont.'d)

68-Pin PLCC



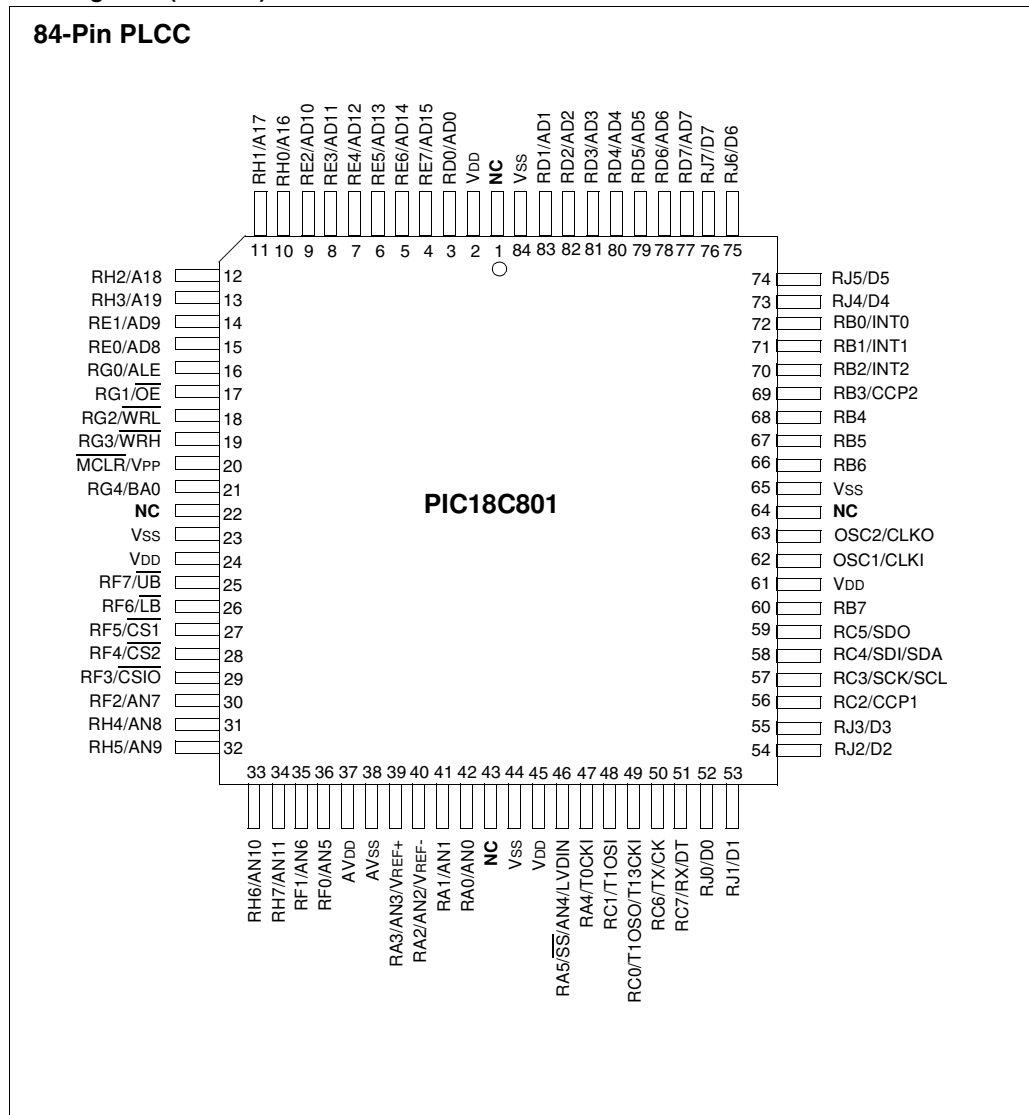
PIC18C601/801

Pin Diagrams (Cont.'d)



Pin Diagrams (Cont.'d)

84-Pin PLCC



PIC18C601/801

Table of Contents

1.0	Device Overview	9
2.0	Oscillator Configurations	21
3.0	RESET	29
4.0	Memory Organization	39
5.0	External Memory Interface	63
6.0	Table Reads/Table Writes	73
7.0	8 X 8 Hardware Multiplier	85
8.0	Interrupts	89
9.0	I/O Ports	103
10.0	Timer0 Module	127
11.0	Timer1 Module	130
12.0	Timer2 Module	135
13.0	Timer3 Module	137
14.0	Capture/Compare/PWM (CCP) Modules	141
15.0	Master Synchronous Serial Port (MSSP) Module	149
16.0	Addressable Universal Synchronous Asynchronous Receiver Transmitter (USART)	177
17.0	10-bit Analog-to-Digital Converter (A/D) Module	193
18.0	Low Voltage Detect	203
19.0	Special Features of the CPU	207
20.0	Instruction Set Summary	215
21.0	Development Support	259
22.0	Electrical Characteristics	265
23.0	DC and AC Characteristics Graphs and Tables	295
24.0	Packaging Information	297
	Appendix A: Data Sheet Revision History	303
	Appendix B: Device Differences	303
	Appendix C: Device Migrations	304
	Appendix D: Migrating from other PICmicro Devices	304
	Appendix E: Development Tool Version Requirements	305
	Index	307
	On-Line Support	315
	Reader Response	316
	Product Identification System	317

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PIC18C601/801

NOTES:

1.0 DEVICE OVERVIEW

This document contains device specific information for the following two devices:

1. PIC18C601
2. PIC18C801

The PIC18C601 is available in 64-pin TQFP and 68-pin PLCC packages. The PIC18C801 is available in 80-pin TQFP and 84-pin PLCC packages.

An overview of features is shown in Table 1-1.

Device block diagrams are provided in Figure 1-1 for the 64/68-pin configuration, and Figure 1-2 for the 80/84-pin configuration. The pinouts for both packages are listed in Table 1-2.

TABLE 1-1: DEVICE FEATURES

Features		PIC18C601	PIC18C801
Operating Frequency		DC - 25 MHz	DC - 25 MHz
External Program Memory	Bytes	256K	2M
	Max. # of Single Word Instructions	128K	1M
Data Memory (Bytes)		1536	1536
Interrupt Sources		15	15
I/O Ports		Ports A - G	Ports A - H, J
Timers		4	4
Capture/Compare/PWM modules		2	2
Serial Communications		MSSP, Addressable USART	MSSP, Addressable USART
10-bit Analog-to-Digital Module		8 input channels	12 input channels
RESETS (and Delays)		POR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)	POR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)
Programmable Low Voltage Detect		Yes	Yes
8-bit External Memory Interface		Yes	Yes
8-bit De-multiplexed External Memory Interface		No	Yes
16-bit External Memory Interfaces		Yes	Yes
On-chip Chip Select Signals		<u>CS1</u>	<u>CS1, CS2</u>
On-chip I/O Chip Select Signal		Yes	Yes
Instruction Set		75 Instructions	75 Instructions
Packages		64-pin TQFP 68-pin PLCC	80-pin TQFP 84-pin PLCC

PIC18C601/801

FIGURE 1-1: PIC18C601 BLOCK DIAGRAM

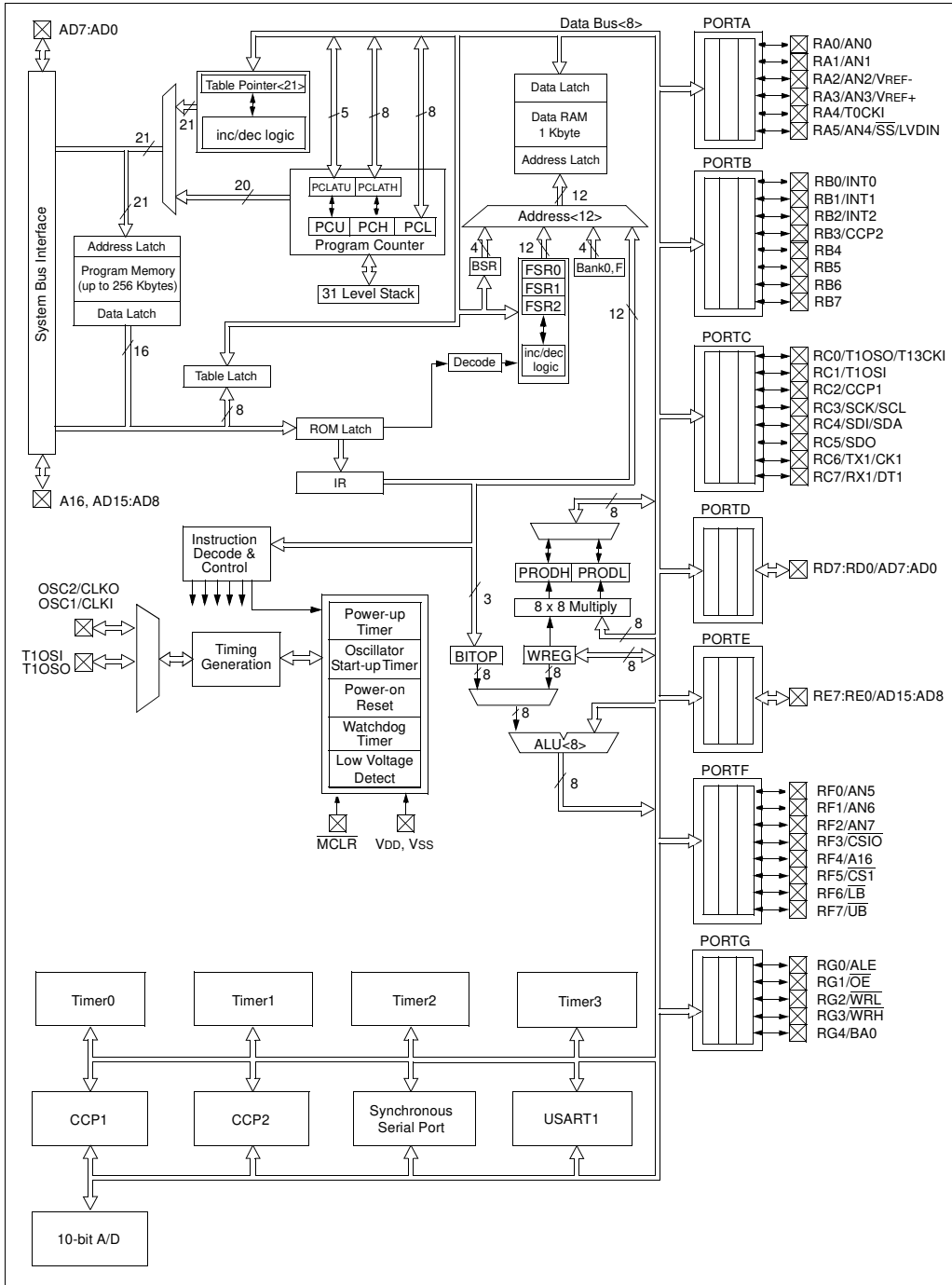
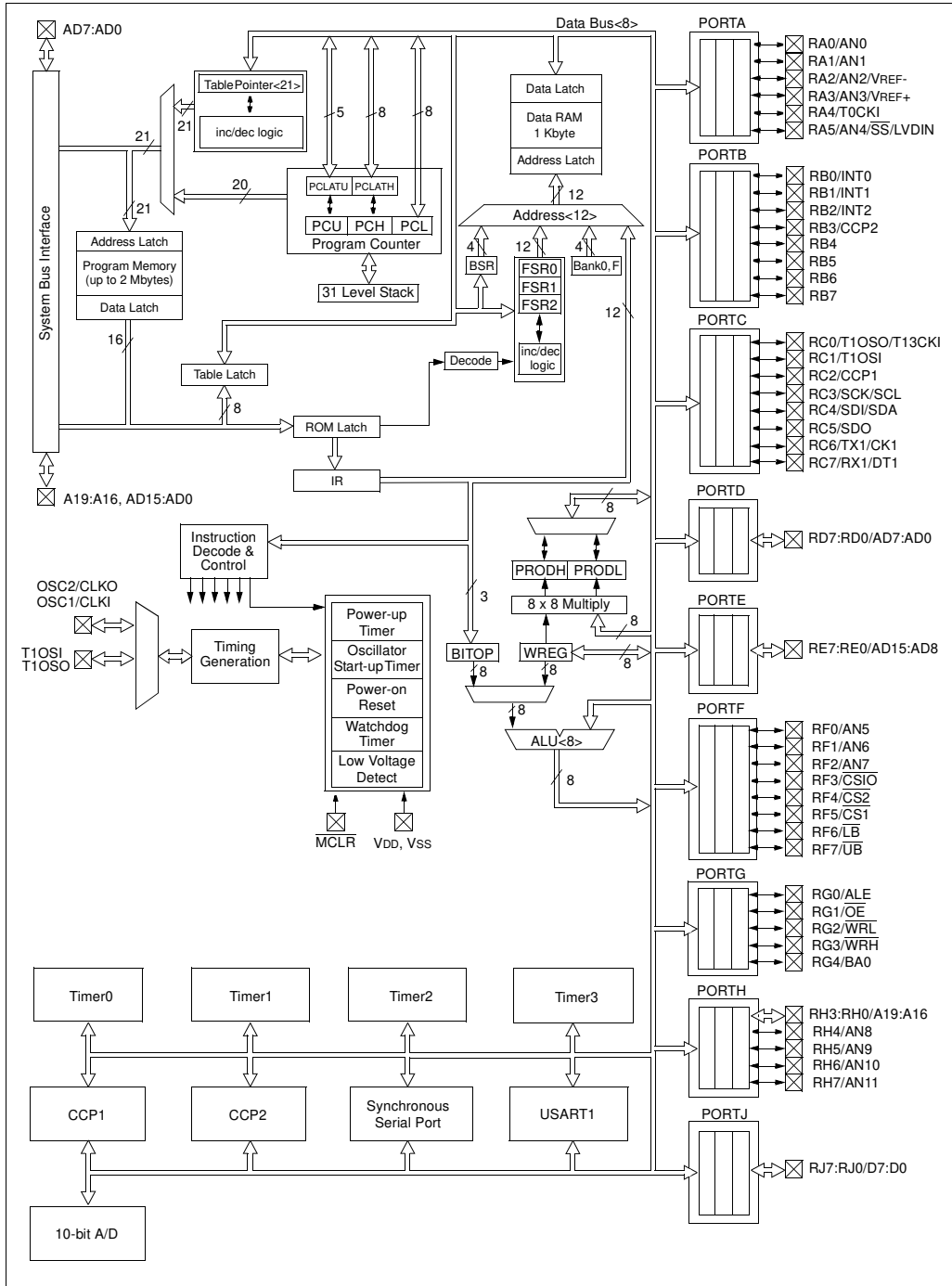


FIGURE 1-2: PIC18C801 BLOCK DIAGRAM



PIC18C601/801

TABLE 1-2: PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
MCLR/VPP MCLR VPP	7	16	9	20	I P	ST	Master clear (RESET) input. This pin is an active low RESET to the device. Programming voltage input.
NC	—	1, 18, 35, 52	—	1, 22, 43, 64	—	—	These pins should be left unconnected.
OSC1/CLKI OSC1 CLKI OSC2/CLKO OSC2 CLKO	39	50	49	62	I I O O	CMOS/ST CMOS — —	Oscillator crystal input or external clock source input. ST buffer when in RC mode. Otherwise CMOS. External clock source input. Always associated with pin function OSC1 (see OSC1/CLKI, OSC2/CLKO pins). Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.

Legend: TTL = TTL compatible input
 ST = Schmitt Trigger input with CMOS levels
 I = Input
 P = Power
 CMOS = CMOS compatible input or output
 Analog = Analog input
 O = Output
 OD = Open Drain (no P diode to VDD)

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RA0/AN0 RA0 AN0	24	34	30	42	I/O I	TTL Analog	PORTA is a bi-directional I/O port. Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	23	33	29	41	I/O I	TTL Analog	Digital I/O. Analog input 1.
RA2/AN2/VREF- RA2 AN2 VREF-	22	32	28	40	I/O I I	TTL Analog Analog	Digital I/O. Analog input 2. A/D reference voltage (Low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	21	31	27	39	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (High) input.
RA4/T0CKI RA4 T0CKI	28	39	34	47	I/O I	ST/OD ST	Digital I/O – Open drain when configured as output. Timer0 external clock input.
RA5/AN4/SS/LVDIN RA5 AN4 SS LVDIN	27	38	33	46	I/O I I I	TTL Analog ST Analog	Digital I/O. Analog input 4. SPI slave select input. Low voltage detect input.

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 I = Input
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 CMOS = CMOS compatible input or output
 Analog = Analog input
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 OD = Open Drain (no P diode to VDD)

PIC18C601/801

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RB0/INT0 RB0 INT0	48	60	58	72	I/O I	TTL ST	PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs. Digital I/O. External interrupt 0.
RB1/INT1 RB1 INT1	47	59	57	71	I/O I	TTL ST	Digital I/O. External interrupt 1.
RB2/INT2 RB2 INT2	46	58	56	70	I/O I	TTL ST	Digital I/O. External interrupt 2.
RB3/CCP2 RB3 CCP2	45	57	55	69	I/O I/O	TTL ST	Digital I/O. Capture2 input, Compare2 output, PWM2 output.
RB4	44	56	54	68	I/O	TTL	Digital I/O, Interrupt-on-change pin.
RB5	43	55	53	67	I/O	TTL	Digital I/O, Interrupt-on-change pin.
RB6	42	54	52	66	I/O I	TTL ST	Digital I/O, Interrupt-on-change pin. ICSP programming clock.
RB7	37	48	47	60	I/O I/O	TTL ST	Digital I/O, Interrupt-on-change pin. ICSP programming data.

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 P = Power

CMOS = CMOS compatible input or output
 Analog = Analog input
 O = Output
 OD = Open Drain (no P diode to VDD)

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RC0/T1OSO/T13CKI RC0 T1OSO T13CKI	30	41	36	49	I/O O I	ST — ST	PORTC is a bi-directional I/O port. Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI RC1 T1OSI	29	40	35	48	I/O I	ST CMOS	Digital I/O. Timer1 oscillator input.
RC2/CCP1 RC2 CCP1	33	44	43	56	I/O I/O	ST ST	Digital I/O. Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL RC3 SCK SCL	34	45	44	57	I/O I/O I/O	ST ST ST	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C mode.
RC4/SDI/SDA RC4 SDI SDA	35	46	45	58	I/O I I/O	ST ST ST	Digital I/O. SPI data in. I ² C data I/O.
RC5/SDO RC5 SDO	36	47	46	59	I/O O	ST —	Digital I/O. SPI data out.
RC6/TX/CK RC6 TX CK	31	42	37	50	I/O O I/O	ST — ST	Digital I/O. USART asynchronous transmit. USART synchronous clock.
RC7/RX/DT RC7 RX DT	32	43	38	51	I/O I I/O	ST ST ST	Digital I/O. USART asynchronous receive. USART synchronous data.

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 I = Input
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CMOS = CMOS compatible input or output
 Analog = Analog input
 O = Output
 OD = Open Drain (no P diode to VDD)

PIC18C601/801

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RD0/AD0 RD0 AD0	58	3	72	3	I/O I/O	ST TTL	PORTD is a bi-directional I/O port. These pins have TTL input buffers when external memory is enabled. Digital I/O. External memory address/data 0.
RD1/AD1 RD1 AD1	55	67	69	83	I/O I/O	ST TTL	Digital I/O. External memory address/data 1.
RD2/AD2 RD2 AD2	54	66	68	82	I/O I/O	ST TTL	Digital I/O. External memory address/data 2.
RD3/AD3 RD3 AD3	53	65	67	81	I/O I/O	ST TTL	Digital I/O. External memory address/data 3.
RD4/AD4 RD4 AD4	52	64	66	80	I/O I/O	ST TTL	Digital I/O. External memory address/data 4.
RD5/AD5 RD5 AD5	51	63	65	79	I/O I/O	ST TTL	Digital I/O. External memory address/data 5.
RD6/AD6 RD6 AD6	50	62	64	78	I/O I/O	ST TTL	Digital I/O. External memory address/data 6.
RD7/AD7 RD7 AD7	49	61	63	77	I/O I/O	ST TTL	Digital I/O. External memory address/data 7.

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CMOS = CMOS compatible input or output
 Analog = Analog input
 O = Output
 OD = Open Drain (no P diode to VDD)

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RE0/AD8	2	11	4	15	I/O	ST	PORTE is a bi-directional I/O port.
RE0 AD8					I/O	TTL	Digital I/O. External memory address/data 8.
RE1/AD9	1	10	3	14	I/O	ST	Digital I/O.
RE1 AD9					I/O	TTL	External memory address/data 9.
RE2/AD10	64	9	78	9	I/O	ST	Digital I/O.
RE2 AD10					I/O	TTL	External memory address/data 10.
RE3/AD11	63	8	77	8	I/O	ST	Digital I/O.
RE3 AD11					I/O	TTL	External memory address/data 11.
RE4/AD12	62	7	76	7	I/O	ST	Digital I/O.
RE4 AD12					I/O	TTL	External memory address/data 12.
RE5/AD13	61	6	75	6	I/O	ST	Digital I/O.
RE5 AD13					I/O	TTL	External memory address/data 13.
RE6/AD14	60	5	74	5	I/O	ST	Digital I/O.
RE6 AD14					I/O	TTL	External memory address/data 14.
RE7/AD15	59	4	73	4	I/O	ST	Digital I/O.
RE7 AD15					I/O	ST	External memory address/data 15.

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 Analog = Analog input
 O = Output
 OD = Open Drain (no P diode to VDD)

PIC18C601/801

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description		
	PIC18C601		PIC18C801						
	TQFP	PLCC	TQFP	PLCC					
RF0/AN5	18	28	24	36	I/O I	ST Analog	PORTF is a bi-directional I/O port. Digital I/O. Analog input 5.		
RF1/AN6	17	27	23	35			I/O I	ST Analog	Digital I/O. Analog input 6.
RF2/AN7	16	26	18	30	I/O I	ST Analog			Digital I/O. Analog input 7.
RF3/ $\overline{\text{CSIO}}$	15	25	17	29			I/O I/O	ST ST	Digital I/O. System bus chip select I/O.
RF4/A16	14	24	—	—	I/O I/O O	ST TTL TTL			Digital I/O. External memory address 16. Chip select 2.
RF4/ $\overline{\text{CS2}}$	—	—	16	28			I/O O	ST TTL	Digital I/O. Chip select 1.
RF5/ $\overline{\text{CS1}}$	13	23	15	27					I/O O
RF6/LB	12	22	14	26	I/O O	ST TTL	Digital I/O. High byte select signal for external memory interface.		
RF7/ $\overline{\text{UB}}$	11	21	13	25			I/O O	ST TTL	Digital I/O.
RF7/UB									High byte select signal for external memory interface.

Legend: TTL = TTL compatible input
 ST = Schmitt Trigger input with CMOS levels
 I = Input
 P = Power

CMOS = CMOS compatible input or output
 Analog = Analog input
 O = Output
 OD = Open Drain (no P diode to VDD)

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RG0/ALE RG0 ALE	3	12	5	16	I/O O	ST TTL	PORTG is a bi-directional I/O port. Digital I/O. Address Latch Enable.
RG1/OE RG1 OE	4	13	6	17	I/O O	ST TTL	Digital I/O. Output Enable.
RG2/WRL RG2 WRL	5	14	7	18	I/O O	ST TTL	Digital I/O. Write Low control.
RG3/WRH RG3 WRH	6	15	8	19	I/O O	ST TTL	Digital I/O. Write High control.
RG4/BA0 RG4 BA0	8	17	10	21	I/O O	ST TTL	Digital I/O. System bus byte address 0.
RH0/A16 RH0 A16	—	—	79	10	I/O O	ST TTL	PORTH is a bi-directional I/O port. Digital I/O. External memory address 16.
RH1/A17 RH1 A17	—	—	80	11	I/O O	ST —	Digital I/O. External memory address 17.
RH2/A18 RH2 A18	—	—	1	12	I/O O	ST —	Digital I/O. External memory address 18.
RH3/A19 RH3 A19	—	—	2	13	I/O O	ST —	Digital I/O. External memory address 19.
RH4/AN8 RH4 AN8	—	—	19	31	I/O I	ST Analog	Digital I/O. Analog input 8.
RH5/AN9 RH5 AN9	—	—	20	32	I/O I	ST Analog	Digital I/O. Analog input 9.
RH6/AN10 RH6 AN10	—	—	21	33	I/O I	ST Analog	Digital I/O. Analog input 10.
RH7/AN11 RH7 AN11	—	—	22	34	I/O I	ST Analog	Digital I/O. Analog input 11.

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PIC18C601/801

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18C601		PIC18C801				
	TQFP	PLCC	TQFP	PLCC			
RJ0/D0	—	—	39	52			PORTJ is a bi-directional I/O port.
RJ0 D0					I/O I/O	ST TTL	Digital I/O. System bus data bit 0.
RJ1/D1	—	—	40	53			
RJ1 D1					I/O I/O	ST TTL	Digital I/O. System bus data bit 1.
RJ2/D2	—	—	41	54			
RJ2 D2					I/O I/O	ST TTL	Digital I/O. System bus data bit 2.
RJ3/D3	—	—	42	55			
RJ3 D3					I/O I/O	ST TTL	Digital I/O. System bus data bit 3.
RJ4/D4	—	—	59	73			
RJ4 D4					I/O I/O	ST TTL	Digital I/O. System bus data bit 4.
RJ5/D5	—	—	60	74			
RJ5 D5					I/O I/O	ST TTL	Digital I/O. System bus data bit 5.
RJ6/D6	—	—	61	75			
RJ6 D6					I/O I/O	ST TTL	Digital I/O. System bus data bit 6.
RJ7/D7	—	—	62	76			
RJ7 D7					I/O I/O	ST TTL	Digital I/O. System bus data bit 7.
VSS	9, 25, 41, 56	19, 36, 53, 68	11,31, 51, 70	23, 44, 65, 84	P	—	Ground reference for logic and I/O pins.
VDD	10,26, 38, 57	2, 20, 37, 49	12,32, 48, 71	2, 24, 45, 61	P	—	Positive supply for logic and I/O pins.
AVSS	20	30	26	38	P	—	Ground reference for analog modules.
AVDD	19	29	25	37	P	—	Positive supply for analog modules.

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 I = Input
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CMOS = CMOS compatible input or output
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2.0 OSCILLATOR CONFIGURATIONS

2.1 Oscillator Types

PIC18C601/801 can be operated in one of four oscillator modes, programmable by configuration bits FOSC1:FOSC0 in CONFIG1H register:

1. LP Low Power Crystal
2. HS High Speed Crystal/Resonator
3. RC External Resistor/Capacitor
4. EC External Clock

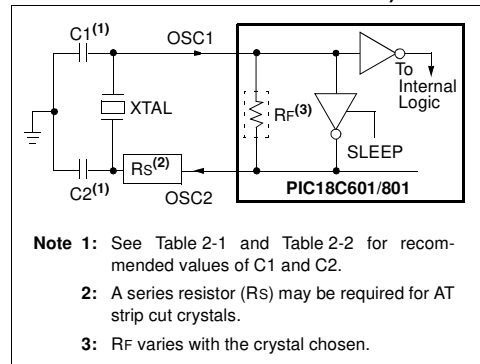
2.2 Crystal Oscillator/Ceramic Resonators

In LP or HS oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 2-1 shows the pin connections. An external clock source may also be connected to the OSC1 pin, as shown in Figure 2-3 and Figure 2-4.

PIC18C601/801 oscillator design requires the use of a parallel cut crystal.

Note: Use of a series cut crystal may give a frequency out of the crystal manufacturer's specifications.

FIGURE 2-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS OR LP OSC CONFIGURATION)



PIC18C601/801

TABLE 2-1: CERAMIC RESONATORS

Ranges Tested:			
Mode	Freq.	OSC1	OSC2
HS	8.0 MHz	10 - 68 pF	10 - 68 pF
	16.0 MHz	10 - 22 pF	10 - 22 pF
	20.0 MHz	TBD	TBD
	25.0 MHz	TBD	TBD
HS+PLL	4.0 MHz	TBD	TBD
These values are for design guidance only. See notes on this page.			
Resonators Used:			
4.0 MHz	Murata Erie CSA4.00MG	± 0.5%	
8.0 MHz	Murata Erie CSA8.00MT	± 0.5%	
16.0 MHz	Murata Erie CSA16.00MX	± 0.5%	
All resonators used did not have built-in capacitors.			

TABLE 2-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freq.	Cap. Range C1	Cap. Range C2
LP	32.0 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
HS	4.0 MHz	15 pF	15 pF
	8.0 MHz	15-33 pF	15-33 pF
	20.0 MHz	15-33 pF	15-33 pF
	25.0 MHz	TBD	TBD
HS+PLL	4.0 MHz	15 pF	15 pF
These values are for design guidance only. See notes on this page.			
Crystals Used			
32.0 kHz	Epson C-001R32.768K-A	± 20 PPM	
200 kHz	STD XTL 200.000kHz	± 20 PPM	
1.0 MHz	ECS ECS-10-13-1	± 50 PPM	
4.0 MHz	ECS ECS-40-20-1	± 50 PPM	
8.0 MHz	EPSON CA-301 8.000M-C	± 30 PPM	
20.0 MHz	EPSON CA-301 20.000M-C	± 30 PPM	

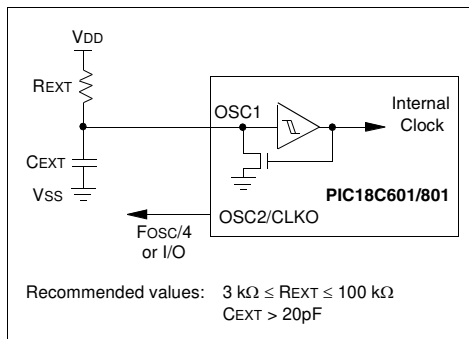
- Note 1:** Recommended values of C1 and C2 are identical to the ranges tested (Table 2-1).
- 2:** Higher capacitance increases the stability of the oscillator, but also increases the start-up time.
- 3:** Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
- 4:** Rs may be required in HS mode to avoid overdriving crystals with low drive level specification.

2.3 RC Oscillator

For timing insensitive applications, the "RC" oscillator mode offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (REXT) and capacitor (CEXT) values and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low CEXT values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 2-2 shows how the RC combination is connected.

In the RC oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic.

FIGURE 2-2: RC OSCILLATOR MODE

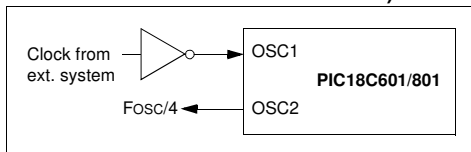


2.4 External Clock Input

The EC oscillator mode requires an external clock source to be connected to the OSC1 pin. The feedback device between OSC1 and OSC2 is turned off in these modes to save current. There is no oscillator start-up time required after a Power-on Reset or after a recovery from SLEEP mode.

In the EC oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 2-3 shows the pin connections for the EC oscillator mode.

FIGURE 2-3: EXTERNAL CLOCK INPUT OPERATION (EC OSC CONFIGURATION)



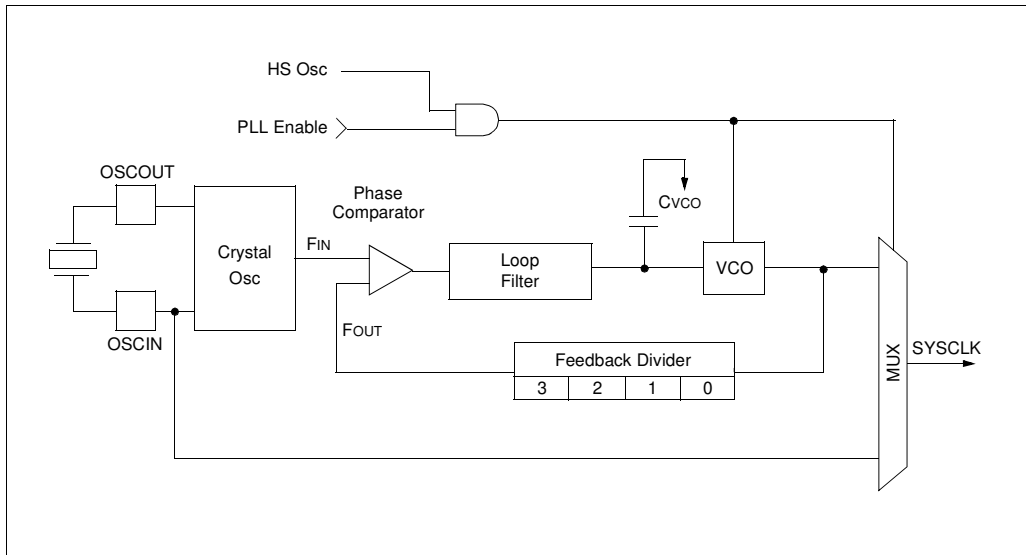
2.5 HS4 (PLL)

A Phase Lock Loop (PLL) circuit is provided as a software programmable option for users that want to multiply the frequency of the incoming crystal oscillator signal by 4. For an input clock frequency of 6 MHz, the internal clock frequency will be multiplied to 24 MHz. This is useful for customers who are concerned with EMI due to high frequency crystals.

The PLL is enabled by configuring HS oscillator mode and setting the PLEN bit in the OSCON register. If HS oscillator mode is not selected, or PLEN bit in OSCCON register is clear, the PLL is not enabled and the system clock will come directly from OSC1. HS oscillator mode is the default for PIC18C601/801. In all other modes, the PLEN bit and the SCS1 bit are forced to '0'.

A PLL lock timer is used to ensure that the PLL has locked before device execution starts. The PLL lock timer has a time-out, referred to as TPLL.

FIGURE 2-4: PLL BLOCK DIAGRAM



PIC18C601/801

2.6 Oscillator Switching Feature

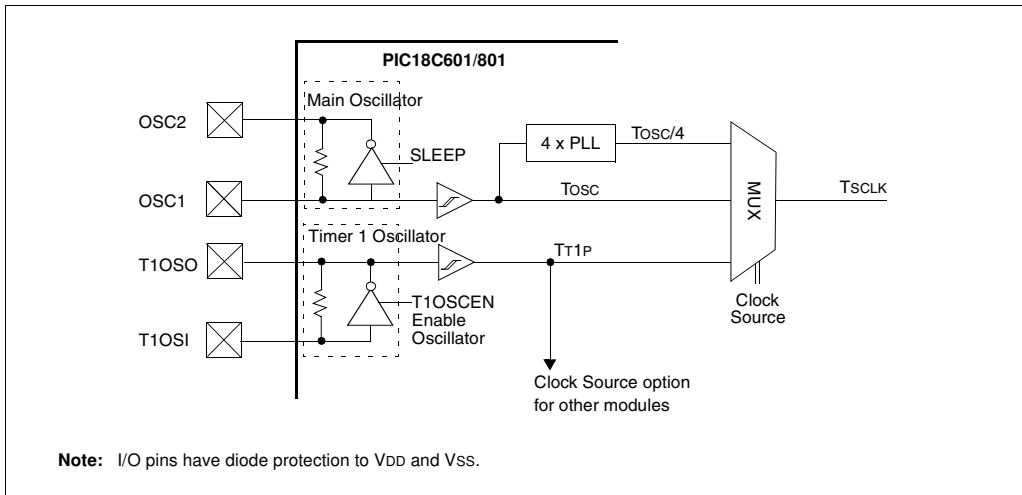
PIC18C601/801 devices include a feature that allows the system clock source to be switched from the main oscillator to an alternate low frequency clock source. For PIC18C601/801 devices, this alternate clock source is the Timer1 oscillator. If a low frequency crystal (32 kHz, for example) has been attached to the Timer1 oscillator pins and the Timer1 oscillator has been enabled, the device can switch to a low power execution mode. Figure 2-5 shows a block diagram of the system clock sources.

2.6.1 SYSTEM CLOCK SWITCH BIT

The system clock source switching is performed under software control. The system clock switch bit, SCS0 (OSCCON register), controls the clock switching. When the SCS0 bit is '0', the system clock source comes from the main oscillator, selected by the FOSC2:FOSC0 configuration bits in CONFIG1H register. When the SCS0 bit is set, the system clock source will come from the Timer1 oscillator. The SCS0 bit is cleared on all forms of RESET.

Note: The Timer1 oscillator must be enabled to switch the system clock source. The Timer1 oscillator is enabled by setting the T1OSCEN bit in the Timer1 control register (T1CON). If the Timer1 oscillator is not enabled, any write to the SCS0 bit will be ignored (SCS0 bit forced cleared) and the main oscillator will continue to be the system clock source.

FIGURE 2-5: DEVICE CLOCK SOURCES



REGISTER 2-1: OSCCON REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	LOCK	PLLEN	SCS1	SCS0
bit 7				bit 0			

bit 7-4	Unimplemented: Read as '0'
bit 3	LOCK: Phase Lock Loop Lock Status bit 1 = Phase Lock Loop output is stable as system clock 0 = Phase Lock Loop output is not stable and cannot be used as system clock
bit 2	PLLEN: Phase Lock Loop Enable bit 1 = Enable Phase Lock Loop output as system clock 0 = Disable Phase Lock Loop
bit 1	SCS1: System Clock Switch bit 1 <u>When PLLEN and LOCK bit are set:</u> 1 = Use PLL output 0 = Use primary oscillator/clock input pin <u>When PLLEN bit or LOCK bit is cleared:</u> Bit is forced clear
bit 0	SCS0: System Clock Switch bit 0 <u>When T1OSCEN bit is set:</u> 1 = Switch to Timer1 oscillator/clock pin 0 = Use primary oscillator/clock input pin <u>When T1OSCEN is cleared:</u> Bit is forced clear

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

2.6.2 OSCILLATOR TRANSITIONS

PIC18C601/801 devices contain circuitry to prevent "glitches" when switching between oscillator sources. Essentially, the circuitry waits for eight rising edges of the clock source that the processor is switching to. This ensures that the new clock source is stable and that its pulse width will not be less than the shortest pulse width of the two clock sources.

A timing diagram indicating the transition from the main oscillator to the Timer1 oscillator is shown in Figure 2-6. The Timer1 oscillator is assumed to be running all the time. After the SCS0 bit is set, the processor is frozen at the next occurring Q1 cycle. After eight synchronization cycles are counted from the Timer1 oscillator, operation resumes. No additional delays are required after the synchronization cycles.

The sequence of events that takes place when switching from the Timer1 oscillator to the main oscillator will depend on the mode of the main oscillator. In addition to eight clock cycles of the main oscillator, additional delays may take place.

If the main oscillator is configured for an external crystal (HS, LP), the transition will take place after an oscillator start-up time (TOST) has occurred. A timing diagram indicating the transition from the Timer1 oscillator to the main oscillator for HS and LP modes is shown in Figure 2-7.